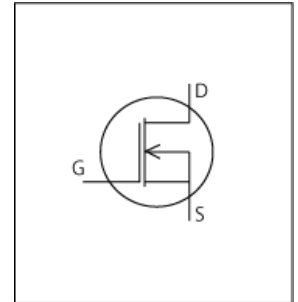


# LTspice Model

## NMOS

### ON Semiconductor

### NVMTS0D7N06CL



#### Model Information

**Model** A macro model based on BSIM3 model  
**Call Name** MDC\_NVMTS0D7N06CL\_LT  
**Pin Assign** 1:G 2:S 3:S 4:S 5:D 6:D 7:D 8:D  
**File List** Model Library MDC\_NVMTS0D7N06CL\_LT01.lib  
Model Report MDC\_NVMTS0D7N06CL\_LT.pdf (this file)

**Verified Simulator Version** LTspice version XVII  
**Note**

#### References

The information which was used for modeling is as follow:

[Data Sheet]

- Date/Version Rev.2
- Product name NVMTS0D7N06CL
- Company name ON Semiconductor.
- Characteristics IdVds[Vgs],IdVgs[Temp],Rds(on)Id[Vgs],Rds(on)Temp[Id],  
Rds(on)Vgs[Temp],Crss,Coss,Ciss,VgsQg[Vdd],IsVsd[Temp],  
tdon,tdoff,tf,tr

#### Simulation Range

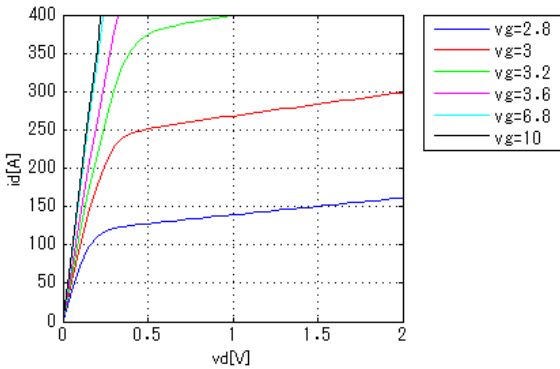
This table shows the range of evaluated simulation range that was not occurs any convergence problems in this area.

Item	Range			Unit
	Min.		Max.	
Drain-source voltage (DC)	0	to	60	V
Gate-source voltage (DC)	0	to	20	V
Temperature	-55	to	175	deg C

Simulation results are following.  
Explanatory notes    — : simulated

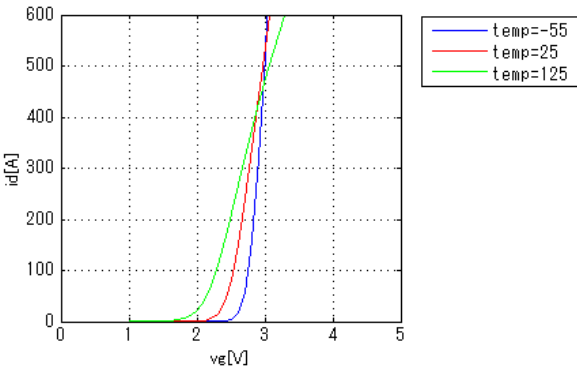
**IdVds[Vgs]**

Temp. = 25deg C

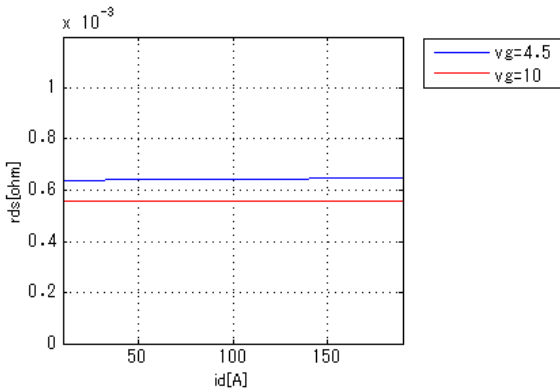


**IdVgs[Temp]**

Vds = 10V

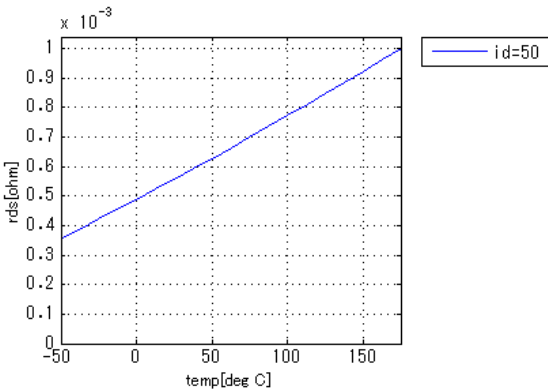


**Rds(on)Id[Vgs]**



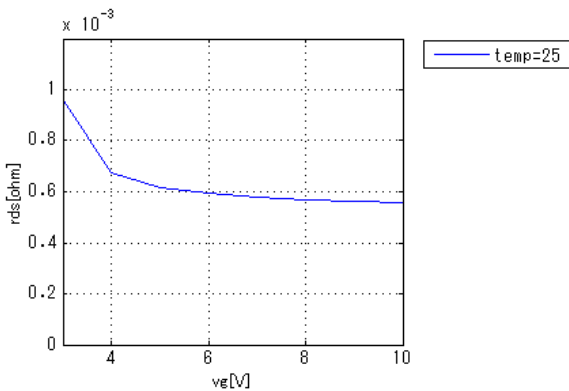
**Rds(on)Temp[Id]**

Vgs = 10V



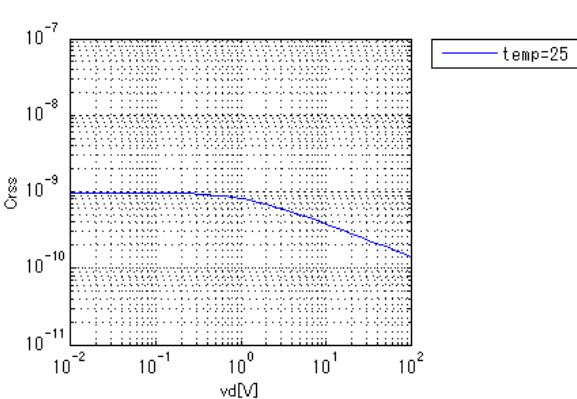
**Rds(on)Vgs[Temp]**

Id = 50A



**Crss**

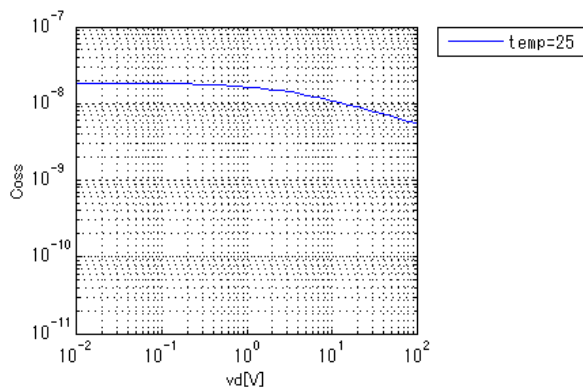
Freq. = 1MHz



Simulation results are following.  
Explanatory notes — : simulated

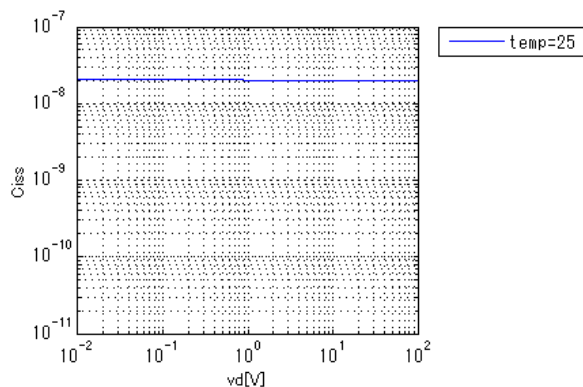
## Coss

Freq. = 1MHz



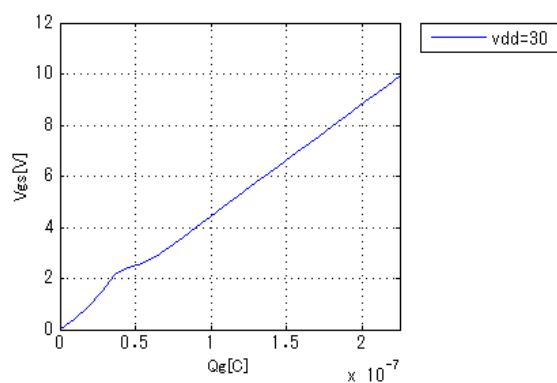
## Ciss

Freq. = 1MHz

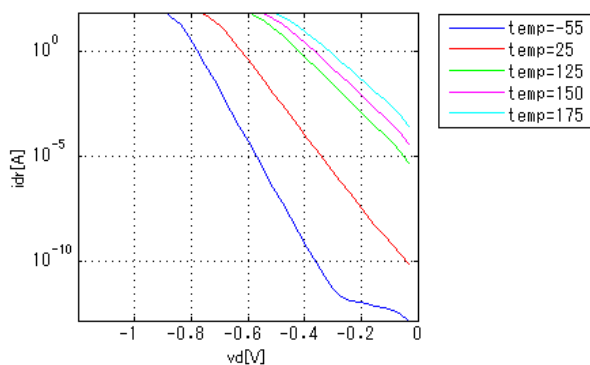


## VgsQg[Vdd]

$I_d = 50A$

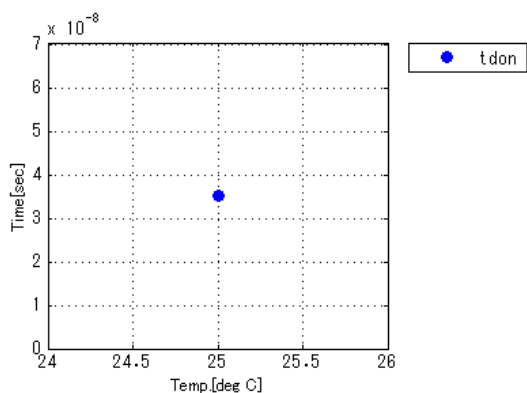


## IsVsd[Temp]



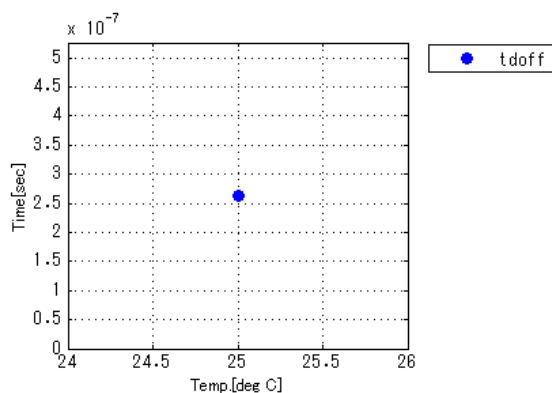
## tdon

Vdd = 30V,  $I_d = 50A$ , +Vg = 10V, -Vg = 0V,  $R_g = 2.5ohm$



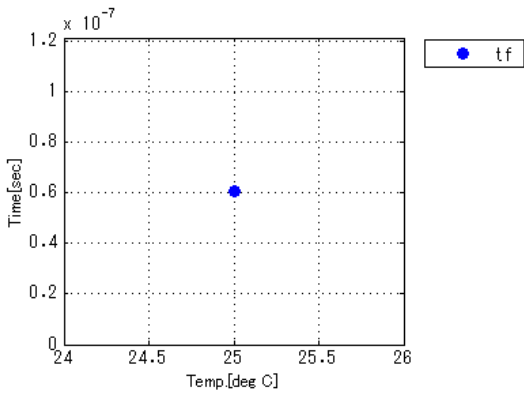
## tdoff

Vdd = 30V,  $I_d = 50A$ , +Vg = 10V, -Vg = 0V,  $R_g = 2.5ohm$

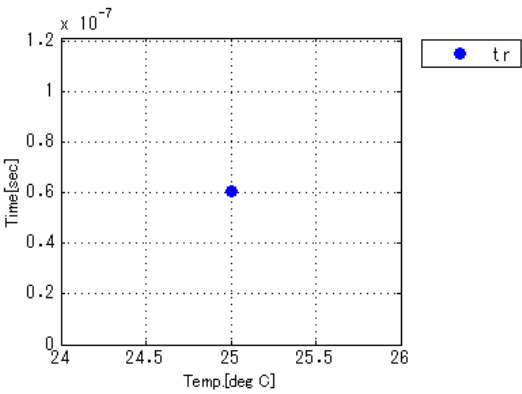


Simulation results are following.  
Explanatory notes    — : simulated

**tf**  
Vdd = 30V, Id = 50A, +Vg = 10V, -Vg = 0V, Rg = 2.5ohm



**tr**  
Vdd = 30V, Id = 50A, +Vg = 10V, -Vg = 0V, Rg = 2.5ohm



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